

## Automotive-grade N-channel 40 V, 1.68 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

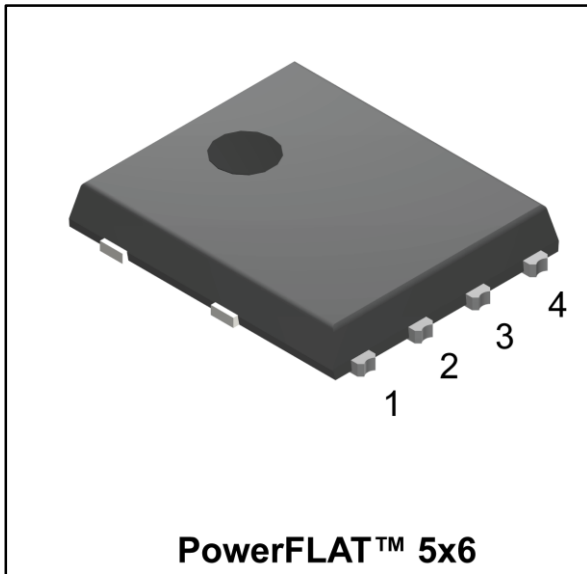
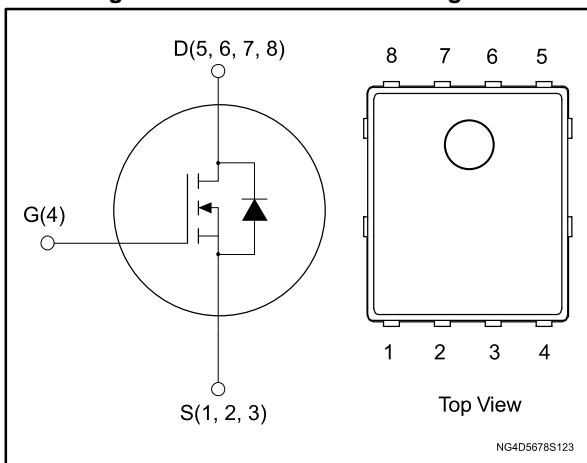


Figure 1: Internal schematic diagram



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STL190N4F7AG	40 V	2.00 mΩ	120 A

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

### Applications

- Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packaging
STL190N4F7AG	190N4F7	PowerFLAT™ 5x6	Tape and reel

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# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	120	A
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	120	A
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	480	A
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	127	W
I <sub>AV</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by maximum junction temperature)	35	A
E <sub>AS</sub>	Single pulse avalanche energy (T <sub>J</sub> = 25 °C, I <sub>D</sub> = 17.5 A, V <sub>DD</sub> = 22 V)	300	mJ
T <sub>j</sub>	Operating junction temperature range	-55 to 175	°C
T <sub>stg</sub>	Storage temperature range		

**Notes:**

<sup>(1)</sup>Drain current is limited by package, the current capability of the silicon is 183 A at 25 °C.

<sup>(2)</sup>Pulse width limited by safe operating area

**Table 3: Thermal data**

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	31.3	°C/W
R <sub>thj-case</sub>	Thermal resistance junction-case	1.18	°C/W

**Notes:**

<sup>(1)</sup>When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t < 10 s.

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

**Table 4: On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	40			V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 40 V			1	μA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17.5 A		1.68	2.00	mΩ

**Table 5: Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	3000	-	pF
C <sub>OSS</sub>	Output capacitance		-	850	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	70	-	pF
Q <sub>g</sub>	Total gate charge	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 35 A, V <sub>GS</sub> = 10 V (see <a href="#">Figure 14</a> : "Test circuit for gate charge behavior")	-	41	-	nC
Q <sub>gs</sub>	Gate-source charge		-	15	-	nC
Q <sub>gd</sub>	Gate-drain charge		-	7	-	nC

**Table 6: Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 17.5 A, R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V (see <a href="#">Figure 13</a> : "Test circuit for resistive load switching times" and <a href="#">Figure 18</a> : "Switching time waveform")	-	19	-	ns
t <sub>r</sub>	Rise time		-	6.4	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	25	-	ns
t <sub>f</sub>	Fall time		-	6.5	-	ns

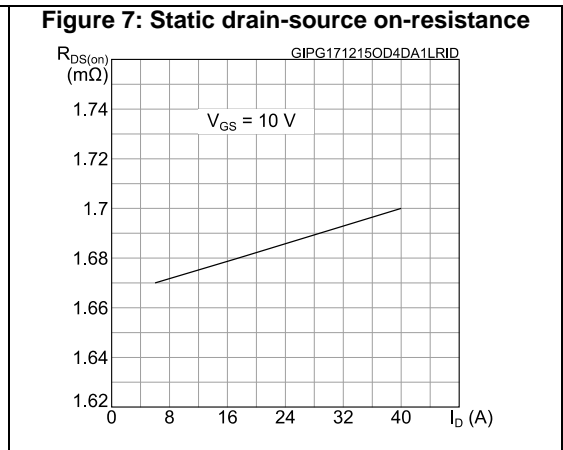
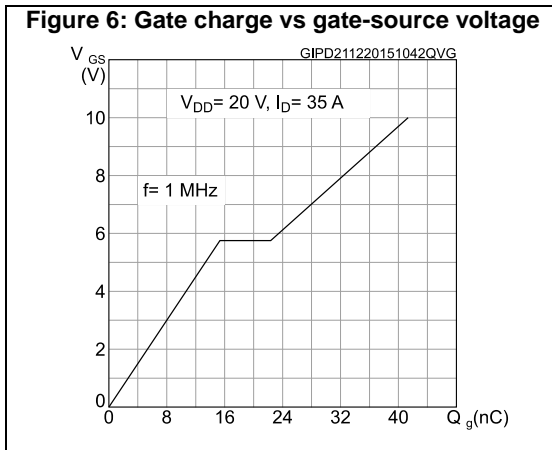
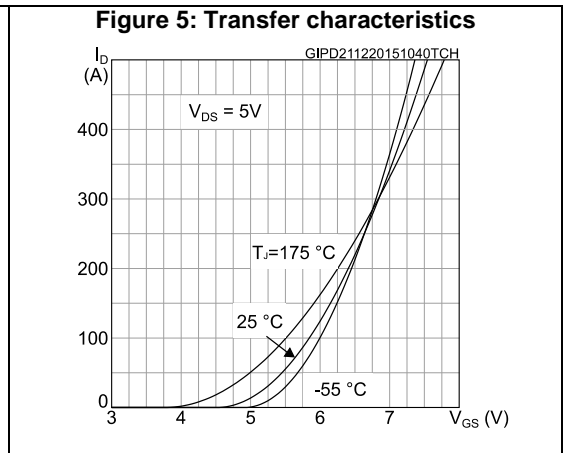
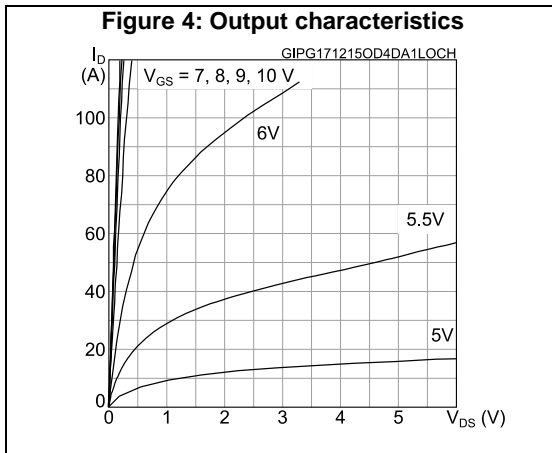
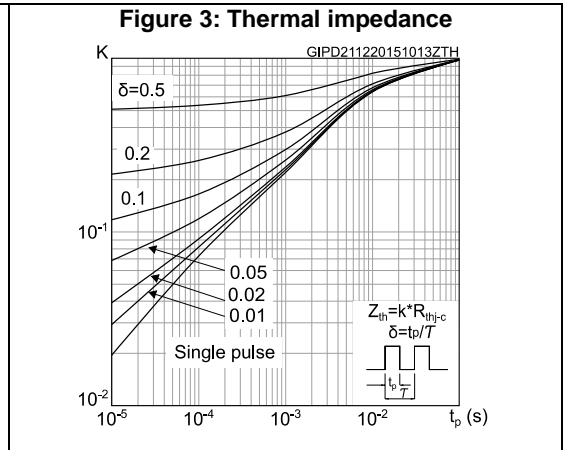
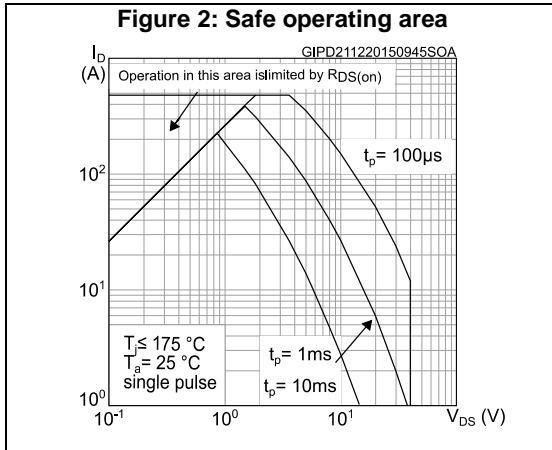
**Table 7: Source-drain diode**

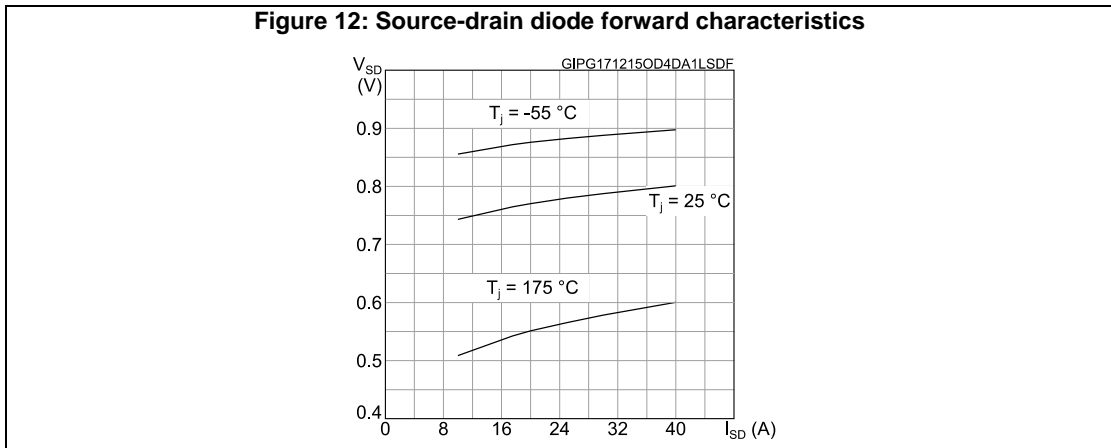
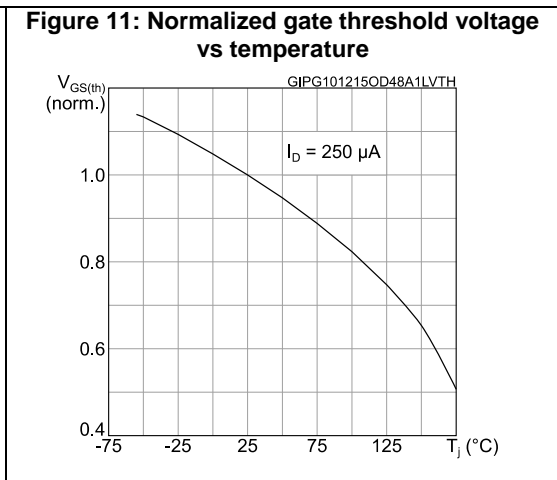
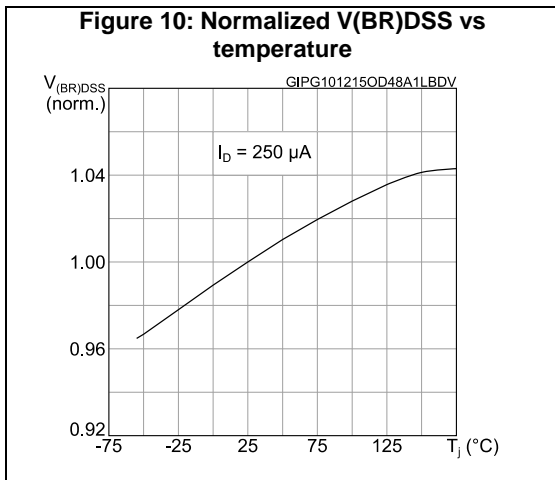
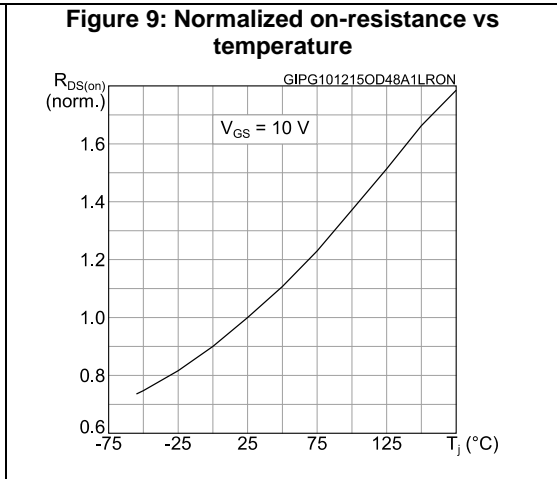
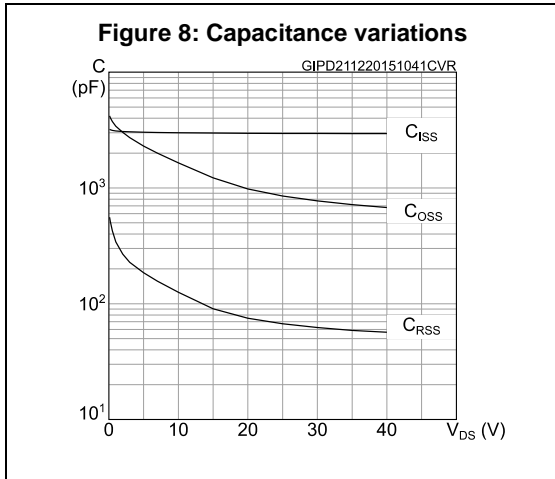
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 35 A, V <sub>GS</sub> = 0 V	-		1.2	V
t <sub>rr</sub>	Reverse recovery time	I <sub>D</sub> = 35 A, di/dt = 100 A/μs V <sub>DD</sub> = 32 V (see <a href="#">Figure 15</a> : "Test circuit for inductive load switching and diode recovery times")	-	43		ns
Q <sub>rr</sub>	Reverse recovery charge		-	43		nC
I <sub>RRM</sub>	Reverse recovery current		-	2		A

**Notes:**

<sup>(1)</sup>Pulsed: pulse duration = 300 μs, duty cycle 1.5%

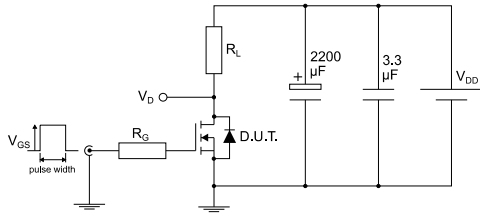
2.1 Electrical characteristics (curves)





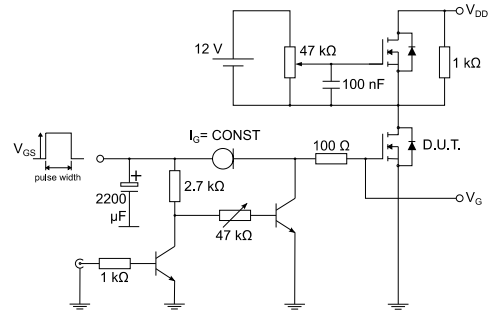
### 3 Test circuits

**Figure 13: Test circuit for resistive load switching times**



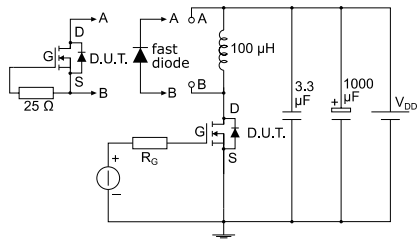
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**Figure 14: Test circuit for gate charge behavior**



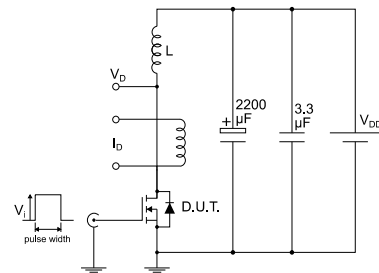
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**Figure 15: Test circuit for inductive load switching and diode recovery times**



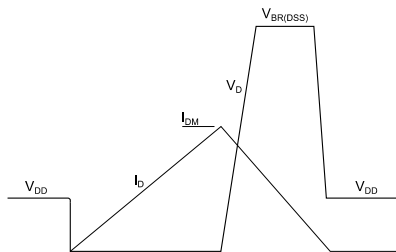
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**Figure 16: Unclamped inductive load test circuit**



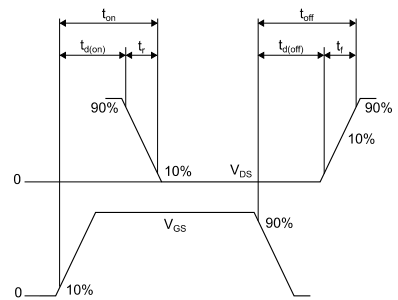
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**Figure 17: Unclamped inductive waveform**



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**Figure 18: Switching time waveform**



AM01473v1

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 PowerFLAT™ 5x6 WF type C package information

Figure 19: PowerFLAT™ 5x6 WF type C package outline

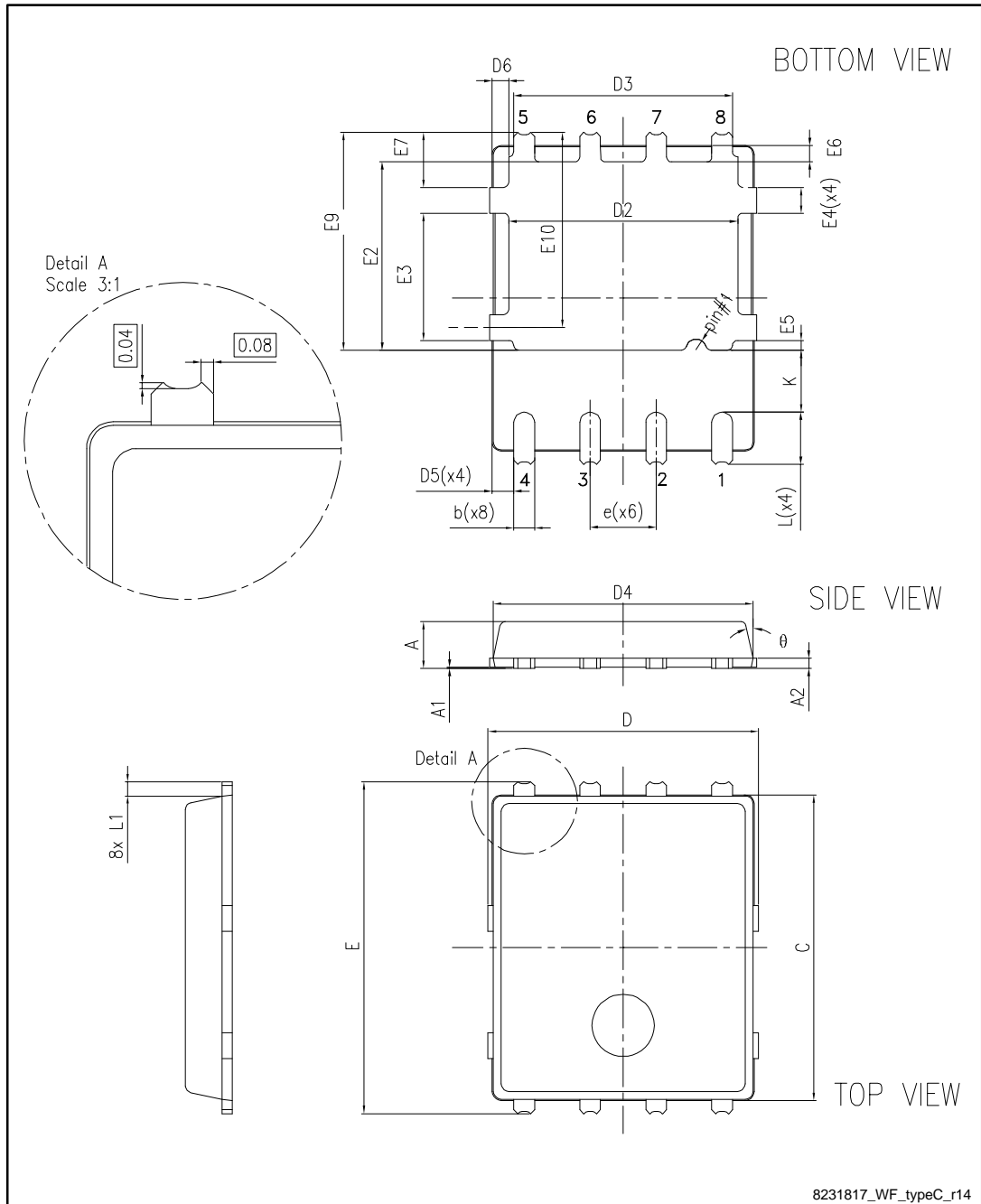
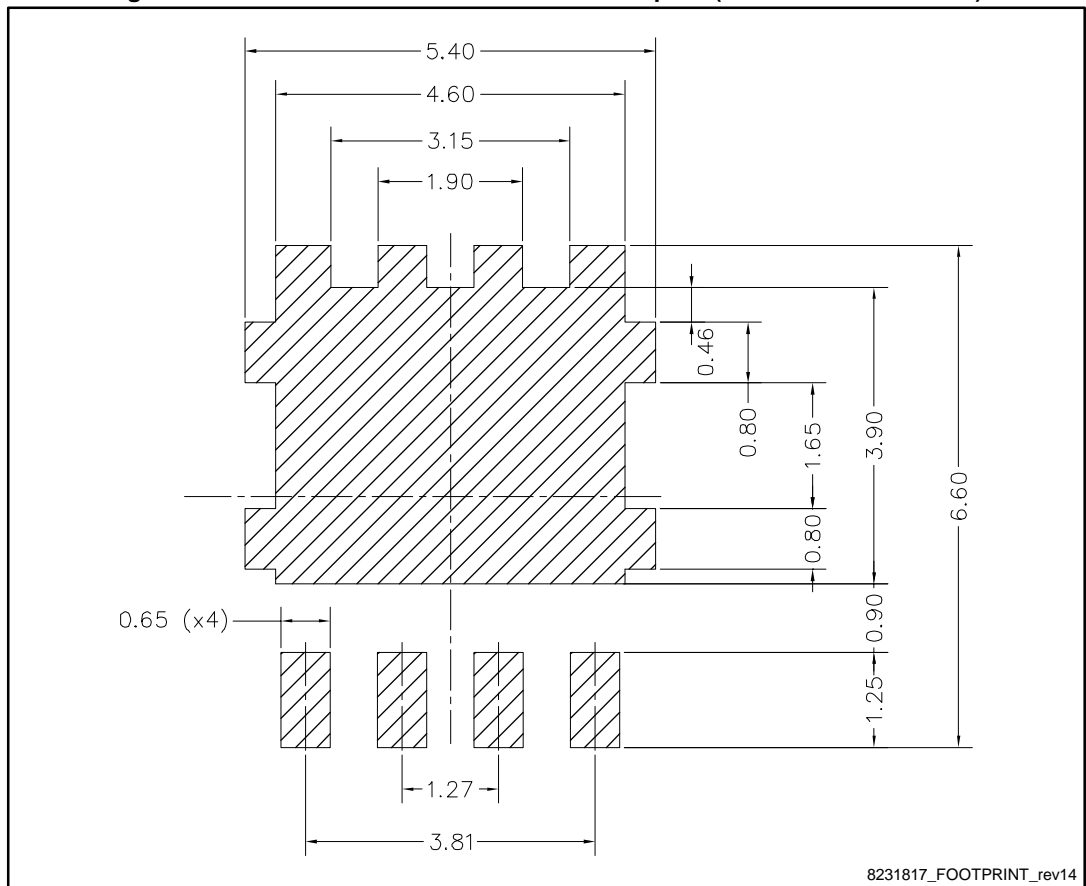




Table 8: PowerFLAT™ 5x6 WF type C mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
e		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.05		1.35
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
θ	0°		12°

Figure 20: PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)



## 4.2 PowerFLAT™ 5x6 packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

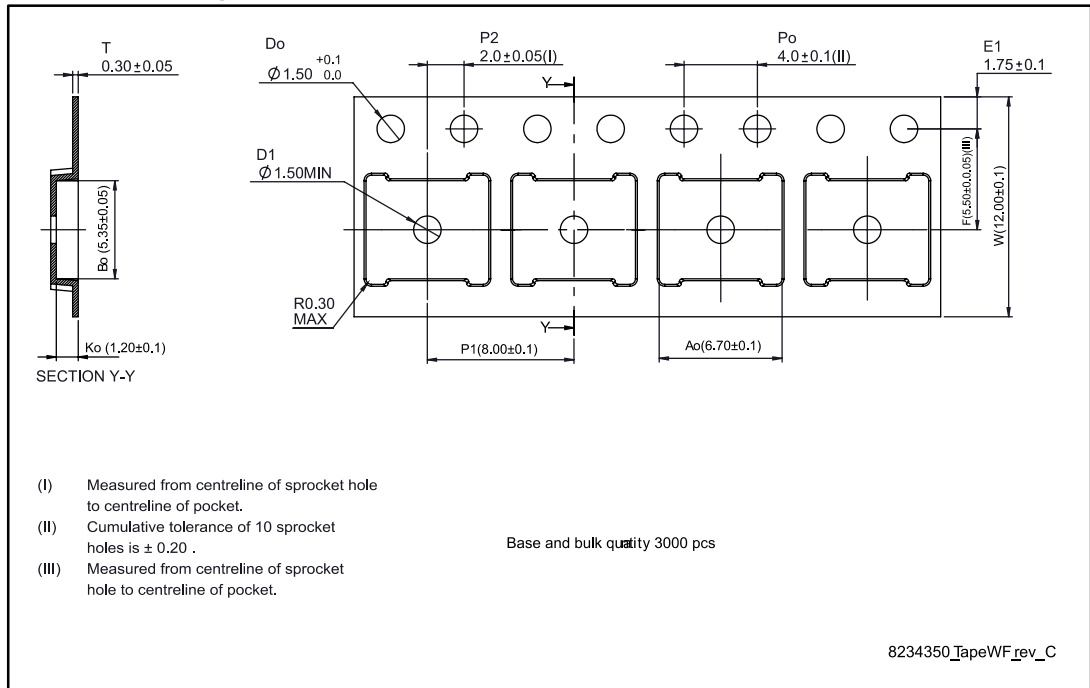


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape

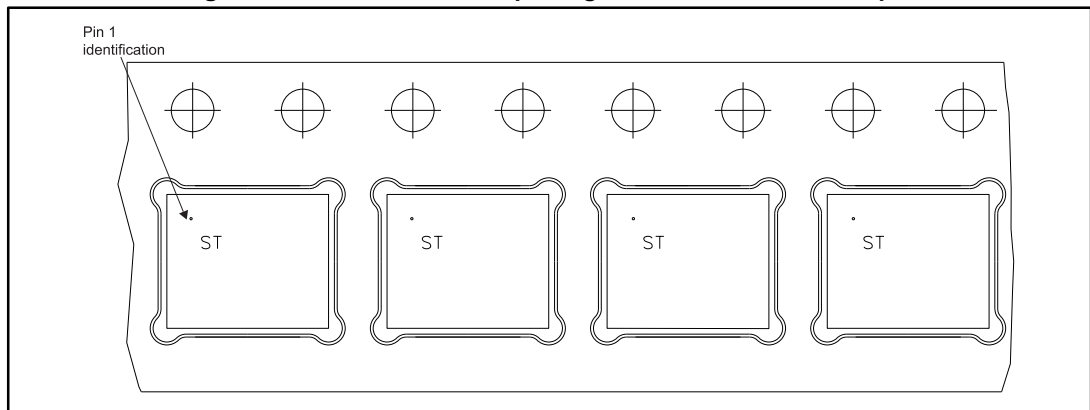
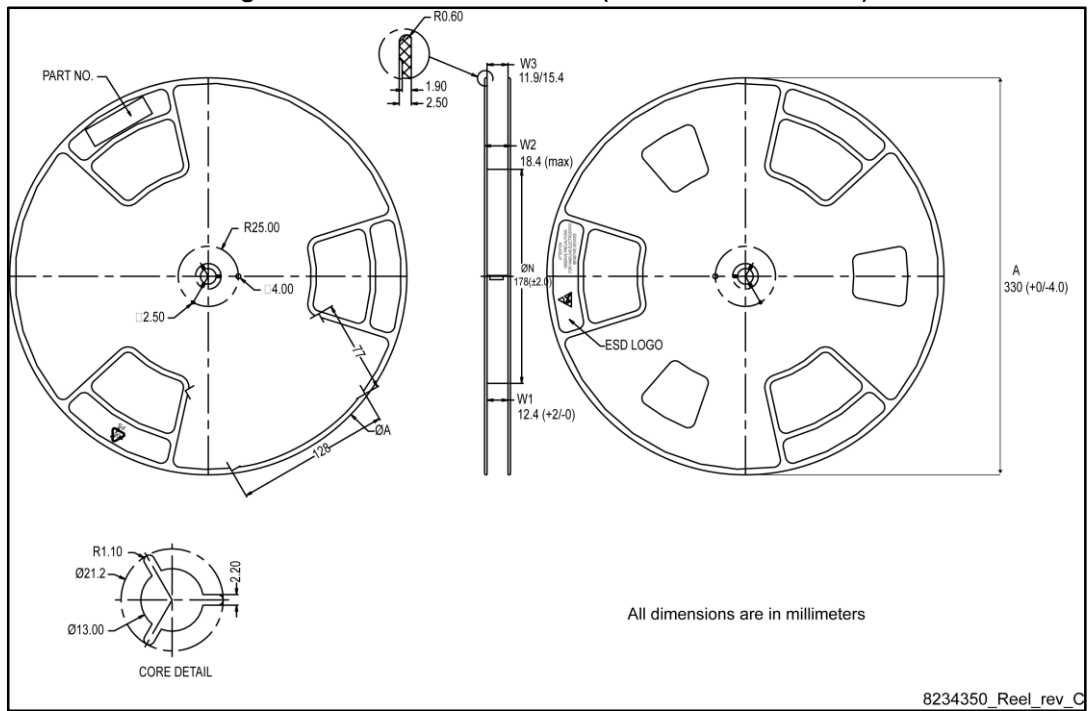


Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)



## 5 Revision history

**Table 9: Document revision history**

Date	Revision	Changes
07-Jan-2016	1	First release.
23-Jun-2016	2	Updated package silhouette and <i>Figure 1: "Internal schematic diagram"</i> in cover page. Updated <i>Section 6.1: "PowerFLAT™ 5x6 WF type C package information"</i> . Minor text changes.

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